

LP8770Q1EVM Evaluation Module User Guide

The Texas Instruments LP8770Q1EVM evaluation module (EVM) helps designers evaluate the operation and performance of the LP8770x-Q1 device. The LP8770Q1EVM is designed to meet the power management requirements of the latest processor and platform needs in automotive camera and radar applications. The device contains two step-down DC-DC converters and two linear regulators and general purpose digital output signal. The device is controlled by an I²C-compatible serial interface.

This document covers EVM hardware, user software provided with the EVM, and design documentation that includes schematics, layout, and bill of materials (BOM) table.



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Trademarks

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1 About This Manual

This user guide covers the evaluation module (EVM) variants listed in Table 1. These variants are referred as LP8770Q1EVM in this user guide.

Table 1.	LP8770Q1EVM
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EVM NUMBER	DEVICE NUMBER		
LP8770Q1EVM	P87702DRHBRQ1, LP87702DRHBRQ1		

2 Related Documentation from Texas Instruments

For related documentation, see the LP87702-Q1 Dual Buck Converter and 5-V Boost With Diagnostic Functions data sheet

3 If You Need Assistance

Contact your local TI sales representative.



Using the LP8770Q1EVM Evalution Board

1 Introduction

The Texas Instruments LP8770Q1EVM evaluation module (EVM) helps designers evaluate the operation and performance of the LP8770x-Q1 device. The LP8770x-Q1 is designed to meet the power management requirements of the latest platform needs especially in automotive radar, camera and cluster applications. The device contains two stepdown DC/DC converters, 5-V boost converter, two voltage monitoring inputs for external power supplies, window watchdog and general purpose digital output signals. The device is controlled by an I²C-compatible serial interface and by an enable signal

This document covers EVM hardware, user software provided with the EVM, and design documentation that includes schematics, layout, and parts list.



Figure 1. LP8770Q1EVM



2 Setup

Setup

This section describes the jumpers and connectors on the EVM as well and how to properly connect, set up, and use the LP8770Q1EVM.

Many of the components on the LP8770Q1EVM are susceptible to damage by electrostatic discharge (ESD). Customers are advised to observe proper ESD handling precautions when unpacking and handling the EVM, including the use of a grounded wrist strap at an approved ESD workstation.

On opening the LP8770Q1EVM package, ensure that these items are included:

- LP8770Q1EVM evaluation board
- USB cable

If any of the items are missing, contact the closest Texas Instruments Product Information Center to inquire about a replacement.

2.1 Input and Output Connectors Description

The description of the main connectors on the EVM board are as follows (see also Figure 1):

- Connector J4 is the power input terminal for the EVM board. The terminal block provides a power (VIN) and ground (GND) connection to allow the user to attach the EVM to a cable harness. Positive and negative voltage sense terminals are also provided.
- Connector J12 is the regulated output voltage of the first buck converter. The terminal block provides a
 power (+) and ground (-) connection to allow the user to attach the EVM to a cable harness for
 connecting a load. Positive and negative voltage sense terminals are also provided; these are
 connected to buck feedback pin and TP1.
- Connector J13 is the regulated output voltage of the second buck converter. The terminal block
 provides a power (+) and ground (-) connection to allow the user to attach the EVM to a cable harness
 for connecting a load. Positive and negative voltage sense terminals are also provided; these are
 connected to buck feedback pin and TP2.
- Connector J14 is the regulated output voltage of the boost converter. The terminal block provides a power (+) and ground (-) connection to allow the user to attach the EVM to a cable harness for connecting a load. Positive and negative voltage sense terminals are also provided. The boost sense is connected close to boost output and TP3.
- Connector J16 connects the USB cable to EVM board. It is compatible with a Mini USB Type B
 receptacle. Jumper J3 (USB2VIN) can be used to connect 5-V USB voltage to device V_{IN}.

2.2 Software Installation

The EVM is controlled through a graphical user interface (GUI) software. The software communicates with the EVM through an available USB port. The minimum hardware requirements for the EVM software are:

- IBM PC-compatible computer running a Microsoft Windows[®] XP or newer operating system
- Available USB port
- Mouse

Software installation:

- 1. Open the LP8770B0_installer.exe.
- 2. Installer prompts to accept the license agreement (see Figure 2).
- 3. Installer prompts to choose which features of LP8770B0 Installer user wants to install (see Figure 3).
- 4. Installer prompts to select Destination Folder (see Figure 4).
- 5. Press Install and the installation starts.
- 6. Installer prompts when installation is complete (see Figure 5).





Figure 2. Installer License Agreement

hoose Components Choose which features of LP8	770B0 Installer you want to inst	all.
Check the components you wa install. Click Next to continue.	int to install and uncheck the co	mponents you don't want to
Select components to install:	Desktop Shortcut ✓ LP877080 EVM GUI	Description Position your mouse over a component to see its description.
Space required: 14.1MB		

Figure 3. Features of the EVM Installation



Figure 4. GUI Destination Folder



Figure 5. GUI Installation Complete

Open the GUI. Connect the EVM to the PC with the USB cable.

- 1. With the power supply disconnected from the unit under test (UUT), open LP8770B0.exe located in the directory selected during installation.
- 2. On the Evaluation SW window bottom left corner, user should see text "Hardware connected". Refer to Figure 6.



Setup

CAN UNIX CAN CAN				
Were Tesh	LP8770 EVM			_ _ ×
Image: definition of the second of	File View Tools Help			
Mm itemusts Config PGOOD Faults Advanced Min Control HST Buck Enable/Disable Pire Enable Diversion	5			
PG1 (GPO1) 0 Bucks and Boost Status bits Buckd Buckd Buckd Buckd Boost 0 Boost 0 WMONL 0 VANA 0	Main Interrupts Config PGOOD Config PGOOD Faults Advance Main Control NRST Buck Enable/Disable Pins EVM NRST Buck Enable/Disable Pins EVM Interrupt active 1 Fins SW Reset WD Reset 0 0 CLKIN (GPO2) 1 PG0 0 0 0 0 0 0	d Clock generator Enable Quency <u>1 MHz</u> WDI signal generator Enable Period <u>1 ms</u> CLKIN / WD_DIS-pin	Watchdog dsable WD_DIS_CTRL Look WD_DIS_CTRL Unlook WD_DIS_CTRL	>_
Auto Write □ Poll Status □ Bus Speed Fast (400kHz) ▼ Read Resisters Write Resisters	PGI (GPOI) 0 Bucks and Boost Enable Mode Multiphase status Current Duck0 Buck1 Boost	Status bits Buck0 0 0 Buck1 0 0 Boost 0 0 VMON1 0 VMON2 0 VANA 0	rgood Current limit 0 0 0	
DC status NACK - A TEVAS INSTRI MENTS				

Figure 6. Evaluation Software GUI When Board is Connected

2.3 Power Supply Setup

A benchtop DC power supply is needed to power up the EVM. For full-load testing of the LP8770Q1EVM, a DC-power supply capable of at least 8 A and 3.3 V is required. 4 A is suggested as a practical minimum for partial load. The power supply is connected to the EVM using connector J4. The power supply and cabling must present low impedance to the UUT; the length of power supply cables must be minimized. Remote sense, using connector J4, can be used to compensate for voltage drops in the cabling.

With the power supply disconnected from the EVM, set the supply to 3.3-V DC and the current limit to 4 A minimum. Set the power supply output OFF. Connect positive terminal (+) of the power supply to VIN and negative terminal (–) to GND on the EVM (J4 power-in terminal block). Check that jumpers on the board are set as shown in Figure 1 (factory default jumper configuration).

Set power supply output ON, and then continue with the following steps:

- 1. Click on NRST check box. See marking 1 in Figure 7. User should see "I2C Status: ready" message on the green background next to the Read Registers button. See also marking 2 in Figure 7.
- 2. Click on EN1 button (marking 3 in Figure 7).

The EVM is now ready for testing with default register settings loaded.



LP8770 EVM					_ _ ×		
File View Tools Help							
Main Interrupts Config PGO Main Control 1 VINST Buck Enable/Deable 3 VINST Buck Enable/Deable 3 VINST Buck Enable/Deable 3 VINST Buck Enable/Deable 3 VINST Buck Enable/Deable	OD Config PGOOD Faults Advanced Pins EVM Clo End Interrupt active 0 End WD Reset 1 Freque GPO0 0 CLXIN (GPO2) 1 P60 0 0 1	k generator WDI signal ger ble Enable por (Mtz.v IN / WD_DIS-pin	erator Watchdog disable @ WD_DIS_CTRL Lock.WD_DIS_CTRL Unlock.WD_DIS_CTRL		>_		
	PG1 (GP01)						
Bucks and Boost	table Count	Status bits	Demonster Committee				
Enable Mode Multiphase	status Current	Buck0 0	Powergood Current limit				
Buck1 Disabled Single Pho	ise 0 mA	Buck1 0	0 0				
Boost	0.1111	Boost	0 0				
		VMON1	0				
		VMON2	0				
		VANA	1				
V Auto Write Poll Status Bus 12	I2C ID 60h V Bus Speed Fast (400	(Hz) Read Registre	rs) (Write Reaisters)				
Hardware connected.				2 [12C state	15: ready 🐌 TEXAS INSTRUMENTS		

Figure 7. Evaluation Software GUI Showing Steps Needed to Power Up the LP8770Q1EVM

2.4 Notes on Efficiency Measurement Procedure

Output connections: An appropriate electronic load or high-power system source meter instrument, specified for operation down to 700 mV, is desirable for loading the EVM. The maximum load current is specified as 8 A. Be sure to choose the correct wire size when attaching the electronic load. A wire resistance that is too high causes a voltage drop in the power distribution path which becomes significant compared to the absolute value of the output voltage. Connect an electric load to J12, J13, or J14. It is advised that, prior to connecting the load, it be set to sink 0 A to avoid power surges or possible shocks

Voltage drop across the PCB traces yield inaccurate efficiency measurements. For the most accurate voltage measurement at the EVM, use TP4 to measure the input voltage and sense terminals to measure the output voltage.

To measure the current flowing to/from the UUT, use the current meter of the DC power supply/electric load as long as it is accurate. Some power source ammeters may show offset of several milliamps and thus will yield inaccurate efficiency measurements. In order to perform very accurate I_{α} measurements on the EVM, disconnect input protective Zener diode D1 by removing the shunt J5 from the board. When connected, this diode causes some leakage, especially at high V_{IN} voltages.

3 GUI Overview

The evaluation software has the following tabs: Main, Config, and Advanced. The three tabs together provide the user access to the whole register map of the device.

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Setup



3.1 Main Tab

The Main tab has the elemental controls for the EVM and provides a view of the device status. Starting from top, the main controls are:

- NRST: This checkbox asserts logic high level voltage to nRST pin, enabling I²C access.
- EN1: This checkbox will assert logic high level voltage to EN1 pin. Asserting EN may enable the buck/LDO boost regulator(s) depending on the register settings.
- Assert SW Reset: To perform a complete SW reset to the chip, click this button. See the LP87702-Q1 device data sheet for explanation of various reset scenarios.
- WDI: This checkbox will assert logic high level voltage to WDI pin.

The "Bucks and Boost" section provides enable controls and status information for bucks and boost as follows:

- Enable check boxes provide enable/disable control for all bucks and boost.
- The "Current" field provides approximate level of load current on each buck.

The System Flags / Interrupts / Pins section as well as the "Interrupt bits" and the "Status bits" sections give data on system faults and warnings. If the interrupt is set for any reason the Interrupt field shall show '1' on red background. The flag causing the interrupt to also be set on the Main tab. Interrupts on the device can only be cleared by writing '1' to associated registers. If "Mask" check-box of certain flag is checked, the interrupt is not generated. The "Status" bits shows the current status of the faults.

At the bottom of the GUI window is the "Auto Write" checkbox. If "Auto Write" is checked (default) any checking, un-checking, or pulldown menu selections immediately launches I2C writes to the chip register(s). If not checked, the user can update the chip registers to correspond the configuration selected on the GUI by clicking "Write Registers".

If "Poll Status" is selected the software sends a query to the device at a fixed interval in order to detect the status of the chip, including operation mode and load current. If not selected, user can read the registers by clicking "Read Registers".

3.2 Other Tabs and Menus

The "Tools" pulldown menu hosts another way of accessing the device registers. The "Direct Register Access" tool can be used to read or write any register. When using direct register access, un-checking the "Poll Status" check-box is recommended. This way the GUI only does the reads and writes commanded from the direct access dialog.

The "Interrupts", "Config", "PGOOD Config", "PGOOD Faults" and "Advanced" tabs provide the user with pulldown menus and check-boxes for the part of the register space that is not covered by the Main tab, such as output voltage control. These controls are self-explanatory. Refer to the device data sheets for explanation of the functions.

3.3 Console

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To show or hide the console, toggle the option in the View pulldown menu. The console can be used to access any of the device registers. Registers can be read or written simply by referring to the logical registers by their name.

The console supports use of scripts. If a text file containing commands supported by the console is stored in the same folder as the evaluation software executable, then the script can be launched from the console by typing the text file name.



4 Board Layout

This section describes the board layout of the LP8770Q1EVM. See the device data sheet for specific PCB layout recommendations. The board is constructed on a 6-layer PCB. Figure 8 shows the top view of the entire board. Routing is mostly done on top and bottom layers. The top layer contains the copper areas connecting the VOUT pads of the inductors and output capacitors together and to the load terminals. The second layer is the ground plane, and the third and fourth layers contain the VIN copper area. Also the bottom layer contains large copper area filled with ground. Input capacitors are placed as close as possible to the device for keeping the critical VIN and GND traces short. Output capacitors and inductors are placed around the input capacitors.



Figure 8. LP8770Q1EVM Board Layout

Board Layout



5 Evaluation Board Schematic



Figure 9. LP8770Q1EVM Schematic





Evaluation Board Schematic







Evaluation Board Schematic

www.ti.com



Figure 11. EVM I²C Interface



6 Bill of Materials

Table 2. LP8770Q1EVM Bill of Materials

Quantity	Designator	Description	Footprint	Part Number	Manufacturer
10	C1, C4, C6, C10, C12, C13, C15, C19, C28, C29	CAP, CERM, 22 uF, 10 V, +/- 10%, X7R, AEC-Q200 Grade 1, 1206	1206_180L	GCM31CR71A226KE02	MuRata
6	C2, C5, C8, C11, C16, C18	CAP, CERM, 10 uF, 10 V, +/- 10%, X7R, 0805	0805L	GCM21BR71A106KE22L	MuRata
3	C3, C9, C17	CAP, CERM, 4.7 uF, 25 V, +/- 10%, X7S, AEC-Q200 Grade 1, 0805	0805L	GCM21BC71E475KE36L	MuRata
1	C20	CAP, CERM, 0.1 uF, 16 V, +/- 10%, X7R, AEC-Q200 Grade 1, 0603	0603L	GCM188R71C104KA37J	MuRata
2	C24, C30	CAP, CERM, 0.22 uF, 25 V, +/- 10%, X7R, AEC-Q200 Grade 1, 0603	0603L	GCM188R71E224KA55D	MuRata
3	C25, C26, C27	CAP, CERM, 100 uF, 10 V, +/- 20%, X5R, 1210	1210_270L	GRM32ER61A107ME20L	MuRata
1	C31	CAP, CERM, 10 pF, 50 V, +/- 5%, C0G/NP0, 0603	0603L	GRM1885C1H100JA01D	MuRata
2	C32, C33	CAP, CERM, 15 pF, 100 V, +/- 5%, C0G/NP0, 0603	0603L	GRM1885C2A150JA01D	MuRata
13	C34, C36, C37, C38, C39, C40, C41, C43, C45, C46, C47, C48, C51	CAP, CERM, 0.1 uF, 25 V, +/- 10%, X7R, 0603	0603L	GRM188R71E104KA01D	MuRata
1	C35	CAP, CERM, 10 uF, 16 V, +/- 20%, X5R, 0603	0603	EMK107BBJ106MA-T	Taiyo Yuden
3	C42, C44, C54	CAP, CERM, 10 uF, 16 V, +/- 20%, X5R, 0603	0603L	EMK107BBJ106MA-T	Taiyo Yuden
1	C49	CAP, CERM, 10 pF, 50 V, +/- 5%, C0G/NP0, 0603	0603	GRM1885C1H100JA01D	MuRata
1	C50	CAP, CERM, 10 uF, 16 V, +/- 10%, X5R, 0805	0805_HV	EMK212BJ106KG-T	Taiyo Yuden
4	C52, C53, C55, C56	CAP, CERM, 1 uF, 25 V, +/- 10%, X5R, 0603	0603	GRM188R61E105KA12D	MuRata
1	D1	Diode, Zener, 5.1 V, 5 W, SMB	SMB	SMBJ5338B-TP	Micro Commercial Components
1	D2	Diode, Schottky, 40 V, 1 A, SOD-123	SOD-123	1N5819HW-7-F	Diodes Inc.
4	H4, H5, H6, H7	Bumpon, Hemisphere, 0.375 X 0.235, Black	Bumpon_SJ61A2	SJ61A2	3M
2	J3, J5	Header, 100mil, 2x1, Gold, TH	TSW-102-07-G-S	TSW-102-07-G-S	Samtec
4	J4, J12, J13, J14	Header, 5mm, 4x1, Tin, TH	Phoenix_1933202	1933202	Phoenix Contact
2	J11, J15	Header, 100mil, 3x1, Gold, TH	TSW-103-07-G-S	TSW-103-07-G-S	Samtec
1	J16	Connector, Receptacle, Mini-USB Type B, R/A, Top Mount SMT	CONN_USB-Mini-B- 1734035-2	1734035-2	TE Connectivity
1	J17	Header, 100mil, 3x1, Gold, TH	Samtec_HTSW- 103-07-G-S	HTSW-103-07-G-S	Samtec
2	L1, L3	Inductor, Shielded, 470 nH, 4.7 A, 0.021 ohm, SMD	DFE252012P	DFE252012PD-R47M	MuRata Toko
3	L2, L4, L6	Ferrite Bead, 30 ohm @ 100 MHz, 4 A, 0805	0805L	BLM21PG300SH1D	MuRata
1	L5	Inductor, Shielded, 1 uH, 3.8 A, 0.035 ohm, AEC-Q200 Grade 1, SMD	DFE252012P	DFE252012PD-1R0M	MuRata Toko
1	L7	Inductor, Wirewound, Ferrite, 10 uH, 0.12 A, 0.5 ohm, SMD	0805_HV	LB2012T100KR	Taiyo Yuden
2	R1, R3	RES, 0, 5%, 0.063 W, AEC-Q200 Grade 0, 0402	0402	CRCW04020000Z0ED	Vishay-Dale
4	R19, R20, R21, R27	RES, 0, 5%, 0.063 W, AEC-Q200 Grade 0, 0402	0402L	CRCW04020000Z0ED	Vishay-Dale
5	R22, R23, R24, R25, R26	RES, 100, 5%, 0.063 W, AEC-Q200 Grade 0, 0402	0402L	CRCW0402100RJNED	Vishay-Dale
5	R29, R30, R31, R32, R33	RES, 100 k, 5%, 0.1 W, AEC-Q200 Grade 0, 0603	0603L	CRCW0603100KJNEA	Vishay-Dale
1	R34	RES, 6.80 k, 1%, 0.1 W, 0603	0603L	RC0603FR-076K8L	Yageo
2	R35, R36	RES, 39.0, 1%, 0.1 W, 0603	0603L	RC0603FR-0739RL	Yageo
2	R37, R38	RES, 1.00 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW06031K00FKEA	Vishay-Dale
1	R39	RES, 1.00, 1%, 0.1 W, 0603	0603L	RC0603FR-071RL	Yageo
4	SH-J1, SH-J2, SH-J3, SH-J4	Shunt, 100mil, Gold plated, Black	SNT-100-BK-G	969102-0000-DA	3M

Bill of Materials

				· ,	
Quantity	Designator	Description	Footprint	Part Number	Manufacturer
16	TP5, TP7, TP8, TP9, TP10, TP11, TP12, TP13, TP14, TP15, TP16, TP17, TP18, TP19, TP20, TP21	Test Point, Miniature, Yellow, TH	Keystone5004	5004	Keystone
2	TP6, TP22	Terminal, Turret, TH, Double	Keystone1502-2	1502-2	Keystone
1	U1	Boost and Dual Buck Regulators With Diagnostic Functions, RHB0032N (VQFN-32)	RHB0032N	LP87702DRHBRQ1	Texas Instruments
1	U2	AT91SAM ARM-based Flash MCU, LQFP100	LQFP100_N	ATSAM3U2CA-AU	Atmel
1	U3	500-mA Low-Noise, Low-IQ LDO, DRV0006A (WSON-6)	DRV0006A	LP5912-3.3DRVR	Texas Instruments
1	U4	250-mA Ultra-Low-Noise, Low-IQ LDO, DBV0005A (SOT-23-5)	DBV0005A_N	LP5907MFX-1.8/NOPB	Texas Instruments
1	Y1	Crystal, 12 MHz, 12pF, SMD	AVX_CX5032GB	CX5032GB12000H0PESZZ	AVX
0	C7, C14	CAP, CERM, 100 uF, 10 V, +/- 20%, X5R, 1210	1210_270L	GRM32ER61A107ME20L	MuRata
0	C21, C22, C23	CAP, CERM, 390 pF, 50 V, +/- 10%, X7R, 0402	0402L	GRM155R71H391KA01D	MuRata
0	FID1, FID2, FID3, FID4, FID5, FID6	Fiducial mark. There is nothing to buy or mount.	Fiducial10-30	N/A	N/A
0	H1, H2, H8, H9	Terminal Block Plug, 4 Pos, 5mm	Phoenix_1704181	1704181	Phoenix Contact
0	J1	JUMPER TIN SMD	HARWIN_S1911- 46R	S1911-46R	Harwin
0	J2, J8	Connector, MMCX,Vertical RCP 6GHz, 50Ohm, TH	CONN_135-9701- 201	135-9701-201	Cinch Connectivity
0	J6, TP1, TP2, TP3, TP4	Header, 100mil, 2x1, Gold, TH	TSW-102-07-G-S	TSW-102-07-G-S	Samtec
0	J7, J9	Receptacle, 2.5mm, 3x2, Gold, SMT	TE_6651712-1	6651712-1	TE Connectivity
0	J10	Header, 100mil, 12x2, Gold, TH	TSW-112-07-G-D	TSW-112-07-G-D	Samtec
0	R2	RES, 0, 5%, 0.063 W, AEC-Q200 Grade 0, 0402	0402	CRCW04020000Z0ED	Vishay-Dale
0	R4, R5, R6	RES, 3.9, 5%, 0.063 W, AEC-Q200 Grade 0, 0402	0402L	CRCW04023R90JNED	Vishay-Dale
0	R7, R8, R9	RES, 0, 5%, 0.063 W, AEC-Q200 Grade 0, 0402	0402L	CRCW04020000Z0ED	Vishay-Dale
0	R10	RES, 0, 5%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW06030000Z0EA	Vishay-Dale
0	R11, R12, R13, R14, R15, R16, R17, R18	RES, 1.8 k, 5%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW06031K80JNEA	Vishay-Dale
0	R28	RES, 50, 1%, 0.1 W, AEC-Q200 Grade 0, 0603	0603	CRCW060350R0FKEA	Vishay-Dale

Table 2. LP8770Q1EVM Bill of Materials (continued)



Page

Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Original (November 2017) to A Revision

- Deleted the FCC Warning section. Refer to the important notices at this end of this document for more information 2
- Changed the connector names, installer name, BOM, and all images for the LP8770B0 revision 4

STANDARD TERMS FOR EVALUATION MODULES

- 1. Delivery: TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or documentation which may be provided together or separately (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.
 - 1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM ("Software") shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms that accompany such Software
 - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
- 2 Limited Warranty and Related Remedies/Disclaimers:
 - 2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
 - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after delivery, or of any hidden defects with ten (10) business days after the defect has been detected.
 - 2.3 TI's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.
- 3 Regulatory Notices:

3.1 United States

3.1.1 Notice applicable to EVMs not FCC-Approved:

FCC NOTICE: This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

- 3.3 Japan
 - 3.3.1 Notice for EVMs delivered in Japan: Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_01.page 日本国内に 輸入される評価用キット、ボードについては、次のところをご覧ください。 http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_01.page
 - 3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

- 1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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- 2. 実験局の免許を取得後ご使用いただく。
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- 3.4 European Union
 - 3.4.1 For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

- 4 EVM Use Restrictions and Warnings:
 - 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
 - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
 - 4.3 Safety-Related Warnings and Restrictions:
 - 4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
 - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
 - 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
- Accuracy of Information: To the extent TI provides information on the availability and function of EVMs, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.

6. Disclaimers:

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- 9. Return Policy. Except as otherwise provided, TI does not offer any refunds, returns, or exchanges. Furthermore, no return of EVM(s) will be accepted if the package has been opened and no return of the EVM(s) will be accepted if they are damaged or otherwise not in a resalable condition. If User feels it has been incorrectly charged for the EVM(s) it ordered or that delivery violates the applicable order, User should contact TI. All refunds will be made in full within thirty (30) working days from the return of the components(s), excluding any postage or packaging costs.
- 10. Governing Law: These terms and conditions shall be governed by and interpreted in accordance with the laws of the State of Texas, without reference to conflict-of-laws principles. User agrees that non-exclusive jurisdiction for any dispute arising out of or relating to these terms and conditions lies within courts located in the State of Texas and consents to venue in Dallas County, Texas. Notwithstanding the foregoing, any judgment may be enforced in any United States or foreign court, and TI may seek injunctive relief in any United States or foreign court.

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